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Image

June 6, 2005

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Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Mail Stop: Issue Fee

Re: U.S. Utility Patent Application ✓
Application No. 09/849,537; Filed: May 7, 2001
For: **Die-Up Ball Grid Array Package with a Heat Spreader and Method
for Making the Same**
Inventors: Zhang *et al.*
Our Ref: 1875.0370000

Sir:

Transmitted herewith for appropriate action are the following documents:

1. Response to Interview Summary; and
2. Return postcard.

It is respectfully requested that the attached postcard be stamped with the date of filing of these documents, and that it be returned to our courier. In the event that extensions of time are necessary to prevent abandonment of this patent application, then such extensions of time are hereby petitioned.

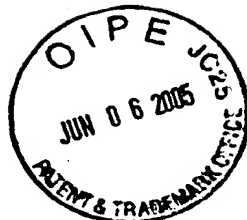
The U.S. Patent and Trademark Office is hereby authorized to charge any fee deficiency, or credit any overpayment, to our Deposit Account No. 19-0036.

Respectfully submitted,

STERNE, KESSLER, GOLDSTEIN & FOX P.L.L.C.

Jeffrey S. Weaver
Attorney for Applicants
Registration No. 45,608

JSW/BSW/tc
Enclosures



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Zhang *et al.*

Appl. No.: 09/849,537

Filed: May 7, 2001

**For: Die-Up Ball Grid Array Package
with a Heat Spreader and Method
for Making the Same**

Confirmation No.: 7984

Art Unit: 2822

Examiner: Lewis, Monica

Atty. Docket: 1875.0370000

Response to Interview Summary

Attn: Mail Stop Issue Fee

Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Sir:

Applicants' representative received the Interview Summary mailed May 4, 2005.

Applicants' representative confirms the substance of the in-person interview of April 21, 2005.

The Examiner is invited to contact the Applicants' undersigned representative at the number provided with any inquiries regarding this Response.

Respectfully submitted,

STERNE, KESSLER, GOLDSTEIN & FOX P.L.L.C.

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Date: 6-6-05

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